Notice of References Cited	Application/Control No. 10/680,391	Applicant(s)/Patent Under Reexamination GRIGG, FORD B.	
	Examiner Chris C. Chu	Art Unit 2815	Page 1 of 1

U.S. PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
	A	US-6,013,946 A	01-2000	Lee et al.	257/684
	B	US-5,577,319 A	11-1996	Knecht, Thomas A.	29/827
	C	US-6,144,102 A	11-2000	Amagai, Masazumi	257/781
	D	US-4,883,730 A	11-1989	Ahne et al.	430/18
	E	US-6,731,010 B2	05-2004	Horiuchi et al.	257/777
	F	US-6,818,474 B2	11-2004	Kim et al.	438/108
	G	US-6,252,298 B1	06-2001	Lee et al.	257/668
	H	US-6,249,052 B1	06-2001	Lin, Paul T.	257/737
	I	US-5,866,949 A	02-1999	Schueller, Randolph D.	257/778
	J	US-5,650,593 A	07-1997	McMillan et al.	174/52.4
	K	US-6,479,887 B1	11-2002	Yoon et al.	257/666
	L	US-6,333,564 B1	12-2001	Katoh et al.	257/780
	M	US-			

FOREIGN PATENT DOCUMENTS

*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
	N	JP 10098130 A	04-1998	Japan	RI et al.	H01L 23/12
	O					
	P					
	Q					
	R					
	S					
	T					

NON-PATENT DOCUMENTS

*		Include as applicable: Author, Title Date, Publisher, Edition or Volume, Pertinent Pages)
	U	Harper, Charles A., "Electronic Packaging and Interconnection HandBook", 1991, pp 1.5 – 1.7, R.R. Donnelley & Sons Company
	V	
	W	
	X	

*A copy of this reference is not being furnished with this Office action. (See MPEP § 707.05(a).)
Dates in MM-YYYY format are publication dates. Classifications may be US or foreign.